3 Schematic

Figure 1 shows the schematic diagram for the EVM.

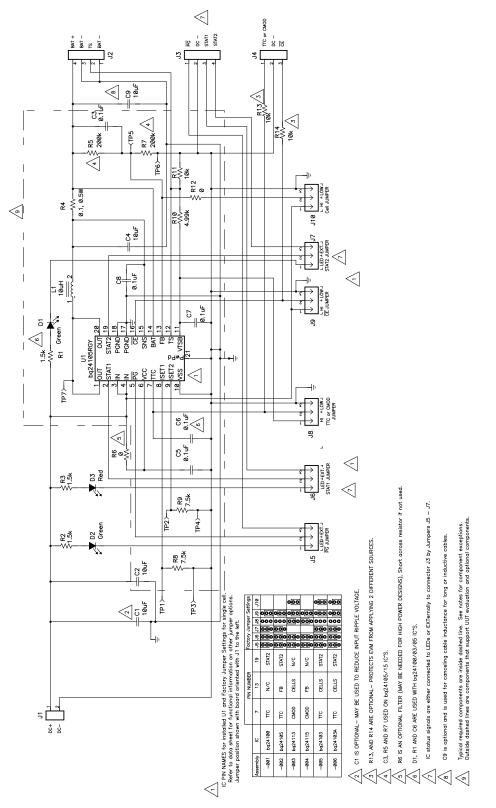


Figure 1. bq241xxEVM Schematic

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